

PATENT
1248-0509P

Applicant:	Kumi MIYACHI et al.	Conf.:	3629
Appl. No.:	09/615,956	Group:	2133
Filed:	July 13, 2000	Examiner:	E. Abraham
For:	SEMICONDUCTOR DEVICE HAVING INTEGRALLY SEALED INTEGRATED CIRCUIT CHIPS ARRANGED FOR IMPROVED TESTING		

MAY 30 2003

Technology Center 2100

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

May 27, 2003

Transmitted herewith is an Amendment After Final in the above-identified application.

- ☐ The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.
- ☐ The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

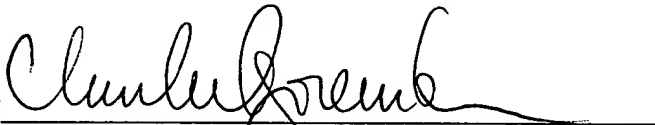
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	14	-	20	=	0	\$ 18	\$0.00
INDEPENDENT	10	-	10	=	0	\$ 84	\$0.00
<input type="checkbox"/> FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$280	\$0.00
						TOTAL	\$0.00

- ☐ Petition for () month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is(are) enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. §§1.16 or 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By 
Charles Gorenstein, #29,271

RWD
CG/RWD/kss
1248-0509P

P.O. Box 747
Falls Church, VA 22040-0747
(703) 205-8000

Attachment(s)

JE
#108 (NE)
6/3/03



MS AF
REPLY UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2133

PATENT
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IN THE U.S. PATENT AND TRADEMARK OFFICE

RECEIVED

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INTEGRATED CIRCUIT CHIPS ARRANGED FOR
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AMENDMENT AFTER FINAL

MS AF

**Assistant Commissioner of Patents
and Trademarks**

May 27, 2003

Sir:

Responsive to the Office Action dated February 27, 2003, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

Entry of the Amendment is Proper because it clarifies the definition of "integrally sealed" intended in the claim. This amendment does not raise new issues but serves to at least place the application in better form for appeal.